

Features

- Formerly a KEKOVARICON product
- Two model sizes available 3255 & 4032
- Operating voltage range (V_{dc}) 14 V to 385 V
- Operating voltage (V_{rms}) 11 V to 300 V
- +85 °C Continuous operating temperature
- UL 94 V-0 Non-flammable thermoplastic encapsulation
- Easily solderable tinned copper sheet
- Available in tape and reel packaging for automatic pick-and-place
- RoHS compliant*

General Information

The PV series of low and medium voltage plastic-encapsulated varistors is designed to protect electronic equipment against voltage surges in the low and medium voltage region. They offer direct SMD equivalents to leaded disc varistors of 5 and 7 mm sizes. The thermoplastic encapsulation is non-flammable and UL 94 V-0 rated. Contacts are made of tinned copper sheet.

PV series varistors are designed for surface mounting and are available in two model sizes.

These transient voltage suppressors cover an operating voltage V_{rms} from 11 V to 300 V, featuring maximum surge currents from 100 A to 1200 A.

Absolute Maximum Ratings

Parameter	Value	Units
Continuous:		
Steady State Applied Voltage		
DC Voltage Range (V _{dc})	14 to 385	V
AC Voltage Range (V _{rms})	11 to 300***	V
Transient:		
Non-Repetitive Surge Current, 8/20 µs Waveform (Imax)	100 to 1200	Α
Non-Repetitive Surge Energy, 10/1000 μ s Waveform (W _{max})	0.6 to 30	J
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature Range	-40 to +125	°C
Threshold Voltage Temperature Coefficient	< +0.05	%/°C
Response Time	< 5	ns
Climatic Category	40 / 85 / 56	

***Varistors with rated voltages of 11 Vrms to 50 Vrms are non-standard and available only upon request.

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*RoHS Directive 2015/863, Mar 31, 2015 and Annex.

Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

Additional Information

PV Series - Low & Medium Voltage Plastic-Encapsulated Varistors

Click these links for more information:

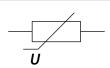


Agency Recognition

Standard	UL 1449
File Number	E313168**

**Not all rated voltages are UL recognized; check the file for details.

Varistor Symbol



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Applications

- Electricity meters
- White goods
- Entertainment electronics
- Power supplies
- Distribution panels
- Sensors

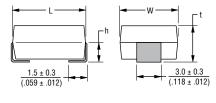
PV Series - Low & Medium Voltage Plastic-Encapsulated Varistors BOURNS

Device Ratings

Model	V _{rms}	V _{dc}	V _n @1mA	٧ _c	I _C	W _{max} 10/1000 μs	P max.	l _{max} 8/20 μs	C Typ. @ 1 kHz
	V	V	V	V	A	J	W	A	pF
PV 11 K 3225	11	14	18	36	2.5	0.6	0.01	100	1600
PV 11 K 4032	11	14	18	36	5	1.1	0.02	250	3100
PV 14 K 3225	14	18	22	43	2.5	0.7	0.01	100	1300
PV 14 K 4032	14	18	22	43	5	1.3	0.02	250	2500
PV 17 K 3225	17	22	27	53	2.5	0.9	0.01	100	1050
PV 17 K 4032	17	22	27	53	5	1.6	0.02	250	1900
PV 20 K 3225	20	26	33	65	2.5	1.1	0.01	100	750
PV 20 K 4032	20	26	33	65	5	2.0	0.02	250	1500
PV 25 K 3225	25	31	39	77	2.5	1.2	0.01	100	660
PV 25 K 4032	25	31	39	77	5	2.4	0.02	250	1260
PV 30 K 3225	30	38	47	93	2.5	1.5	0.01	100	580
PV 30 K 4032	30	38	47	93	5	2.8	0.02	250	1050
PV 35 K 3225	35	45	56	110	2.5	1.8	0.01	100	460
PV 35 K 4032	35	45	56	110	5	3.4	0.02	250	850
PV 40 K 3225	40	56	68	135	2.5	2.2	0.01	100	400
PV 40 K 4032	40	56	68	135	5	4.1	0.02	250	720
PV 50 K 3225	50	65	82	135	5	2.5	0.10	400	390
PV 50 K 4032	50	65	82	135	10	6.5	0.25	1200	820
PV 60 K 3225	60	85	100	165	5	3.0	0.10	400	330
PV 60 K 4032	60	85	100	165	10	7.0	0.25	1200	680
PV 75 K 3225	75	100	120	200	5	4.0	0.10	400	270
PV 75 K 4032	75	100	120	200	10	9.0	0.25	1200	550
PV 95 K 3225	95	125	150	250	5	6.0	0.10	400	220
PV 95 K 4032	95	125	150	250	10	11.0	0.25	1200	440
PV 115 K 3225	115	150	180	300	5	6.5	0.10	400	180
PV 115 K 4032	115	150	180	300	10	13.0	0.25	1200	360
PV 130 K 3225	130	170	205	340	5	7.0	0.10	400	160
PV 130 K 4032	130	170	205	340	10	15.0	0.25	1200	320
PV 140 K 3225	140	180	220	360	5	7.5	0.10	400	150
PV 140 K 4032	140	180	220	360	10	18.0	0.25	1200	300
PV 150 K 3225	150	200	240	395	5	9.0	0.10	400	140
PV 150 K 4032	150	200	240	395	10	18.5	0.25	1200	280
PV 175 K 3225	175	225	270	455	5	9.5	0.10	400	120
PV 175 K 4032	175	225	270	455	10	21.0	0.25	1200	250
PV 230 K 3225	230	300	360	595	5	10.0	0.10	400	95
PV 230 K 4032	230	300	360	595	10	23.0	0.25	1200	190
PV 250 K 3225	250	320	390	650	5	11.0	0.10	400	80
PV 250 K 4032	250	320	390	650	10	25.0	0.25	1200	180
PV 275 K 3225	275	350	430	710	5	13.0	0.10	400	75
PV 275 K 4032	275	350	430	710	10	29.0	0.25	1200	160
PV 300 K 3225	300	385	470	775	5	15.0	0.10	400	70
PV 300 K 4032	300	385	470	775	10	30.0	0.25	1200	150

Product Dimensions

	Dimension				
Model	$h \pm \frac{0.3}{(.012)}$	$L \pm \frac{0.5}{(.020)}$	$W \pm \frac{0.4}{(.016)}$	$t \pm \frac{0.3}{(.012)}$	
PV 11 K 3225	1.7	<u>8.0</u>	<u>6.3</u>	<u>3.4</u>	
	(.066)	(.315)	(.248)	(.134)	
PV 11 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 14 K 3225	<u>1.7</u>	<u>8.0</u>	<u>6.3</u>	<u>3.4</u>	
	(.066)	(.315)	(.248)	(.134)	
PV 14 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 17 K 3225	<u>1.7</u> (.066)	<u>8.0</u> (.315)	$\frac{6.3}{(.248)}$	$\frac{3.4}{(.134)}$	
PV 17 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 20 K 3225	<u>1.7</u> (.066)	<u>8.0</u> (.315)	$\frac{6.3}{(.248)}$	<u>3.4</u> (.134)	
PV 20 K 4032	<u>2.3</u> (.091)	<u>10.0</u> (.394)	$\frac{8.0}{(.315)}$	<u>4.7</u> (.185)	
PV 25 K 3225	<u>1.7</u>	<u>8.0</u>	<u>6.3</u>	<u>3.4</u>	
	(.066)	(.315)	(.248)	(.134)	
PV 25 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 30 K 3225	<u>1.7</u>	<u>8.0</u>	<u>6.3</u>	<u>3.4</u>	
	(.066)	(.315)	(.248)	(.134)	
PV 30 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 35 K 3225	<u>1.7</u>	<u>8.0</u>	<u>6.3</u>	<u>3.4</u>	
	(.066)	(.315)	(.248)	(.134)	
PV 35 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 40 K 3225	<u>1.7</u> (.066)	<u>8.0</u> (.315)	$\frac{6.3}{(.248)}$	<u>3.4</u> (.134)	
PV 40 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 50 K 3225	<u>1.7</u> (.066)	<u>8.0</u> (.315)	$\frac{6.3}{(.248)}$	$\frac{3.4}{(.134)}$	
PV 50 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 60 K 3225	<u>1.7</u>	<u>8.0</u>	<u>6.3</u>	<u>3.4</u>	
	(.066)	(.315)	(.248)	(.134)	
PV 60 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 75 K 3225	<u>1.7</u>	<u>8.0</u>	<u>6.3</u>	<u>3.4</u>	
	(.066)	(.315)	(.248)	(.134)	
PV 75 K 4032	<u>2.3</u>	<u>10.0</u>	8.0	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 95 K 3225	<u>1.7</u> (.066)	<u>8.0</u> (.315)	$\frac{6.3}{(.248)}$	$\frac{3.4}{(.134)}$	
PV 95 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 115 K 3225	<u>1.7</u> (.066)	<u>8.0</u> (.315)	$\frac{6.3}{(.248)}$	<u>3.4</u> (.134)	
PV 115 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 130 K 3225	<u>1.7</u>	<u>8.0</u>	<u>6.3</u>	<u>3.4</u>	
	(.066)	(.315)	(.248)	(.134)	
PV 130 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	
PV 140 K 3225	<u>1.7</u>	<u>8.0</u>	<u>6.3</u>	<u>3.4</u>	
	(.066)	(.315)	(.248)	(.134)	
PV 140 K 4032	<u>2.3</u>	<u>10.0</u>	<u>8.0</u>	<u>4.7</u>	
	(.091)	(.394)	(.315)	(.185)	

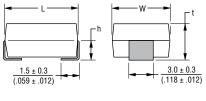


DIMENSIONS:

MM (INCHES)

Product Dimensions (Continued)

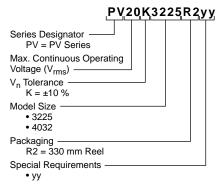
	Dimension					
Model	$h \pm \frac{0.3}{(.012)}$	$L \pm \frac{0.5}{(.020)}$	$W \pm \frac{0.4}{(.016)}$	$t \pm \frac{0.3}{(.012)}$		
PV 150 K 3225	<u>1.7</u> (.066)	<u>8.0</u> (.315)	$\frac{6.3}{(.248)}$	$\frac{3.4}{(.134)}$		
PV 150 K 4032	<u>2.3</u> (.091)	<u>10.0</u> (.394)	<u>8.0</u> (.315)	$\frac{4.7}{(.185)}$		
PV 175 K 3225	<u>2.3</u> (.091)	<u>8.0</u> (.315)	$\frac{6.3}{(.248)}$	<u>4.7</u> (.185)		
PV 175 K 4032	<u>2.3</u> (.091)	<u>10.0</u> (.394)	<u>8.0</u> (.315)	$\frac{4.7}{(.185)}$		
PV 230 K 3225	<u>2.3</u> (.091)	<u>8.0</u> (.315)	<u>6.3</u> (.248)	<u>4.7</u> (.185)		
PV 230 K 4032	<u>2.3</u> (.091)	<u>10.0</u> (.394)	<u>8.0</u> (.315)	<u>4.7</u> (.185)		
PV 250 K 3225	<u>2.3</u> (.091)	<u>8.0</u> (.315)	<u>6.3</u> (.248)	<u>4.7</u> (.185)		
PV 250 K 4032	<u>2.3</u> (.091)	<u>10.0</u> (.394)	<u>8.0</u> (.315)	$\frac{4.7}{(.185)}$		
PV 275 K 3225	<u>2.3</u> (.091)	<u>8.0</u> (.315)	<u>6.3</u> (.248)	$\frac{4.7}{(.185)}$		
PV 275 K 4032	<u>2.3</u> (.091)	<u>10.0</u> (.394)	<u>8.0</u> (.315)	<u>4.7</u> (.185)		
PV 300 K 3225	<u>2.3</u> (.091)	<u>8.0</u> (.315)	<u>6.3</u> (.248)	$\frac{4.7}{(.185)}$		
PV 300 K 4032	<u>2.3</u> (.091)	<u>10.0</u> (.394)	<u>8.0</u> (.315)	<u>4.7</u> (.185)		



DIMENSIONS:

MM (INCHES)

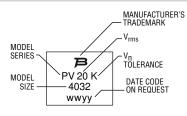
How to Order



Instructions for Creating Orderable Part Number:

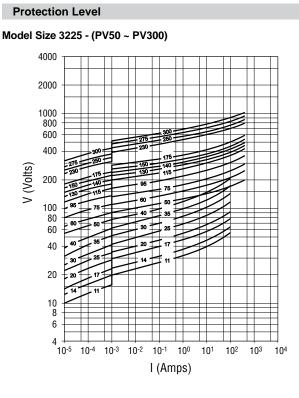
- 1) Start with base part number in characteristics table (example: <u>PV20K3225</u>).
- Add Packaging: R2 (example part number becomes PV20K3225<u>R2</u>).
- 3) Part number can have no spaces or lower case letters.

Typical Part Marking



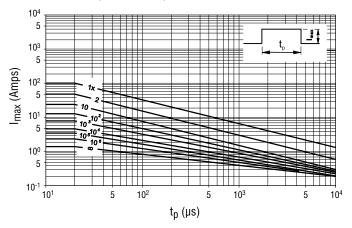
Specifications are subject to change without notice.

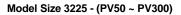
Users should verify actual device performance in their specific applications.

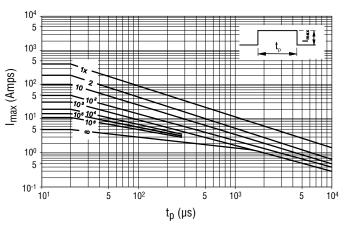


Pulse Rating Curves

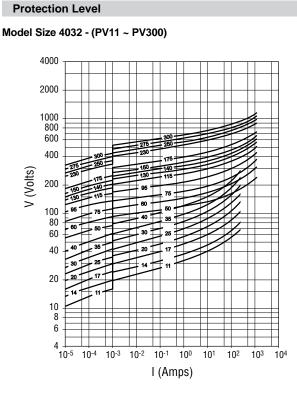
Model Size 3225 - (PV11 ~ PV40)





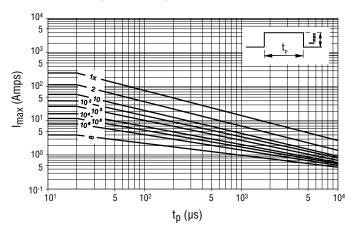


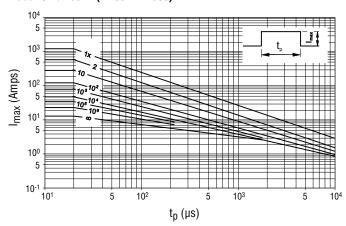
Specifications are subject to change without notice.



Pulse Rating Curves

Model Size 4032 - (PV11 ~ PV40)

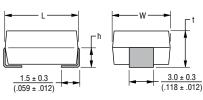


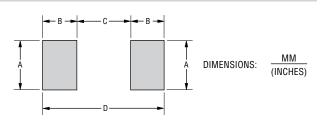


Model Size 4032 - (PV50 ~ PV300)

Specifications are subject to change without notice.

Soldering Pad Configuration



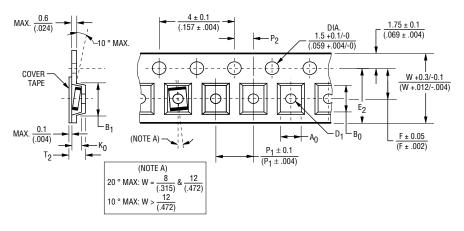


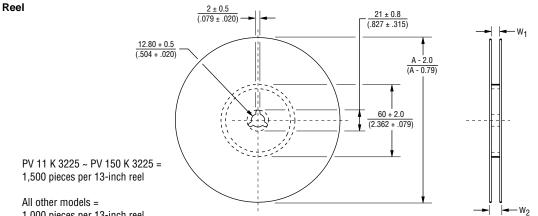
	Voltage		Dimension						
Size	Range (V)	$h \pm \frac{0.3}{(.012)}$	$L \pm \frac{0.5}{(.020)}$	$W \pm \frac{0.4}{(.016)}$	$t \pm \frac{0.3}{(.012)}$	A	В	С	D
3225	11 to 150	<u>1.7</u> (.066)	<u>8.0</u> (.315)	<u>6.3</u> (.248)	$\frac{3.4}{(.134)}$	<u>3.5</u> (.138)	<u>2.9</u> (.114)	<u>4.5</u> (.177)	<u>10.3</u> (.406)
3225	175 to 300	<u>2.3</u> (.091)	<u>8.0</u> (.315)	<u>6.3</u> (.248)	<u>4.7</u> (.185)	<u>3.5</u> (.138)	<u>2.9</u> (.114)	<u>4.5</u> (.177)	<u>10.3</u> (.406)
4032	11 to 300	<u>2.3</u> (.091)	<u>10.0</u> (.394)	<u>8.3</u> (.327)	<u>4.7</u> (.185)	$\frac{3.5}{(.138)}$	<u>2.9</u> (.114)	$\frac{6.5}{(.256)}$	<u>12.3</u> (.484)

Packaging Specifications

Conforms to IEC Publication 286-3 Ed. 4: 2007-06

Таре





1,000 pieces per 13-inch reel

Dimension	Model Size		
Dimension	3225	4032	
Size	7 (.276)	<u>8.6</u> (.339)	
A ₀	7.8 (.307)	<u>10.8</u> (.425)	
B ₀	<u>3.7</u> (.146)		
к ₀ мах.	<u>12.1</u> (.476)		
B ₁ MAX.	<u>1.5</u> (.059)		
D ₁ DIA. MAX.	<u>14.25</u> (.561)		
e ₂	<u>1</u> (.4	<u>2</u> 72)	

Dimension	Model Size			
Dimension	3225	4032		
P ₁	7.5 (.295)			
F	<u>16.0</u> (.630)			
W	<u>9.5</u> (.374)			
T ₂ MAX.	$\frac{16.4 + 2}{(.646 + .079)}$			
W ₁	<u>22.4</u> (.882)			
W ₂ MAX.	$\frac{15.9}{(.626)}$ to $\frac{19.4}{(.764)}$			
A DIA.	<u>330</u> (12.992)			

DIMENSIONS:

MM (INCHES)

Specifications are subject to change without notice.

Soldering Recommendations for SMD Components

Popular soldering techniques used for surface mounted components are Wave and Infrared Reflow processes. Both processes can be performed with Pb-containing or Pb-free solders. The termination options available for these soldering techniques are AgPd and Barrier Type End Terminations.

End Termination	Designation	Recommended and Suitable for	RoHS Compliant
Ag/Pd	PV SeriesR1	Pb-containing soldering	Yes
Barrier Type End Termination	PV SeriesN R1	Pb-containing and Pb-free soldering	Yes
NiSn End Termination	PV SeriesNi R1	Pb-containing and Pb-free soldering	Yes

Wave Soldering

This process is generally associated with discrete components mounted on the underside of printed circuit boards, or for large top-side components with bottom-side mounting tabs to be attached, such as the frames of transformers, relays, connectors, etc. SMD varistors to be wave soldered are first glued to the circuit board, usually with an epoxy adhesive. When all components on the PCB have been positioned and an appropriate amount of time is allowed for adhesive curing, the completed assembly is then placed on a conveyor and run through a single, double wave process.

Infrared Reflow Soldering

These reflow processes are typically associated with top-side component placement. This technique utilizes a mixture of adhesive and solder compounds (and sometimes fluxes) that are blended into a paste. The paste is then screened onto PCB soldering pads specifically designed to accept a particular sized SMD component. The recommended solder paste wet layer thickness is 100 to 300 μ m. Once the circuit board is fully populated with SMD components, it is placed in a reflow environment, where the paste is heated to slightly above its eutectic temperature. When the solder paste reflows, the SMD components are attached to the solder pads.

Solder Fluxes

Solder fluxes are generally applied to populated circuit boards to keep oxides from forming during the heating process and to facilitate the flowing of the solder. Solder fluxes can be either a part of the solder paste compound or separate materials, usually fluids. Recommended fluxes are:

- · non-activated (R) fluxes, whenever possible
- mildly activated (RMA) fluxes of class L3CN
- class ORLO

Activated (RA), water soluble or strong acidic fluxes with a chlorine content > 0.2 wt. % are NOT RECOMMENDED. The use of such fluxes could create high leakage current paths along the body of the varistor components.

When a flux is applied prior to wave soldering, it is important to completely dry any residual flux solvents prior to the soldering process.

Thermal Shock

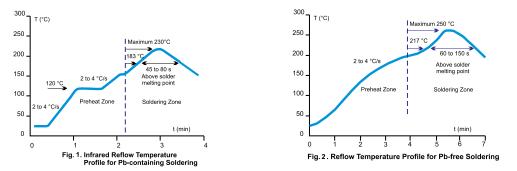
To avoid the possibility of generating stresses in the varistor chip due to thermal shock, a preheat stage to within 100 °C of the peak soldering process temperature is recommended. Additionally, SMD varistors should not be subjected to a temperature gradient greater than 4 °C/sec., with an ideal gradient being 2 °C/sec. Peak temperatures should be controlled. Wave and Reflow soldering conditions for SMD varistors with Pb-containing solders are shown on the next page in Fig. 1 and 2 respectively, while Wave and Reflow soldering conditions for SMD varistors with Pb-free solders are shown in Fig. 1 and 3.

Whenever several different types of SMD components are being soldered, each having a specific soldering profile, the soldering profile with the least heat and the minimum amount of heating time is recommended. Once soldering has been completed, it is necessary to minimize the possibility of thermal shock by allowing the hot PCB to cool to less than 50 °C before cleaning.

Specifications are subject to change without notice.

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Users should verify actual device performance in their specific applications.
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Soldering Recommendations for SMD Components (Continued)



Inspection Criteria

When Infrared Reflow processes are used, the inspection criteria to determine acceptable solder joints will depend on several key variables, principally termination material process profiles.

Solder Test and Retained Samples

Reflow soldering test based on J-STD-020D.1 and soldering test by dipping based on IEC 60068- 2 for Pb-free solders are performed on each production lot. Test results and accompanying samples are retained for a minimum of two (2) years. The solderability of a specific lot can be checked at any time within this period, should a customer require this information.

Rework Criteria - Soldering Iron

Unless absolutely necessary, the use of soldering irons is NOT recommended for reworking variators encapsulated in plastic. If no other means of rework is available, the following criteria must be strictly followed:

- Do not allow the tip of the iron to directly contact the top of the plastic
- Do not exceed the following soldering iron specifications:

Storage Conditions

SMD varistors should be used within 1 year of purchase to avoid possible soldering problems caused by oxidized terminals. The storage environment should be controlled, with humidity less than 40 % and temperature between -25 and +45 °C. Varistor chips should always be stored in their original packaged unit.

Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

Reliability Testing Procedures

Varistor test procedures comply with CECC 42200, IEC 1051-1/2 (and AEC-Q200, if applicable). Test results are available upon customer request. Special tests can be performed upon customer request.

Reliability Parameter	Test	Tested According to	Condition to be Satisfied after Testing
AC/DC Bias Reliability	AC/DC Bias Reliability AC/DC Life Test AC/DC L		lδV _n (1 mA)l < 10 %
Pulse Current Capability	I _{max} 8/20 µs	CECC 42200, Test C 2.1 or IEC 1051-1, Test 4.5 10 pulses in the same direction at 2 pulses per minute at maximum peak current for 10 pulses	IōV _n (1 mA)l < 10 % no visible damage
Pulse Energy Capability	ulse Energy Capability $W_{max} 10/1000 \mu s$ $W_{max} 10/1000 \mu s$ $U = C = C + 2200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$ $U = C + 200, \text{ Test C } 2.1 \text{ or}$		lδV _n (1 mA)l < 10 % no visible damage
WLD Capability	WLD x 10	ISO 7637, Test pulse 5, 10 pulses at rate of 1 per minute	lδV _n (1 mA)l < 15 % no visible damage
V _{jump} Capability	V _{jump} 5 min.	Increase of supply voltage to $V \ge V_{jump}$ for 1 minute	lδV _n (1 mA)l < 15 % no visible damage
Environmental and Storage Reliability	Climatic Sequence	 CECC 42200, Test 4.16 or IEC 1051-1, Test 4.17 a) Dry heat, 16h, UCT, Test Ba, IEC 68-2-2 b) Damp heat, cyclic, the first cycle: 55 °C, 93 % RH, 24 h, Test Db 68-2-4 c) Cold, LCT, 2 h, Test Aa, IEC 68-2-1 d) Damp heat cyclic, remaining 5 cycles: 55 °C, 93 % RH, 24 h/cycle, Test Bd, IEC 68-2-30 	lδV _n (1 mA)l < 10 %
	Thermal Shock	CECC 42200, Test 4.12, Test Na, IEC 68-2-14, AEC-Q200 Test 16, 5	lδV _n (1 mA)l < 10 % no visible damage
	Steady State Damp Heat	CECC 42200, Test 4.17, Test Ca, IEC 68-2-3, AEC-Q200 Test 6, 56 days, 40 °C, 93 % RH, AEC-Q200 Test 7: Bias, Rh, T all at 85.	lδV _n (1 mA)l < 10 %
Storage Test		IEC 68-2-2, Test Ba, AEC-Q200 Test 3, 1000 h at maximum storage temperature	lδV _n (1 mA)l < 5 %

Continued on Next Page

Specifications are subject to change without notice.

Reliability Testing Procedures (Continued)

Reliability Parameter	Test	Tested According to	Condition to be Satisfied after Testing
	Solderability	CECC 42200, Test 4.10.1, Test Ta, IEC 68-2-20 solder bath and reflow method	Solderable at shipment and after 2 years of storage, criteria: >95% must be covered by solder for reflow meniscus
	Resistance to Soldering Heat	CECC 42200, Test 4.10.2, Test Tb, IEC 68-2-20 solder bath nad reflow method	lδV _n (1 mA)l < 5 %
	Terminal Strength	JIS-C-6429, App. 1, 18N for 60 sec same for AEC-Q200 Test 22	No visual damage
Mechanical Reliability	Board Flex	JIS-C-6429, App. 2, 2 mm min. AEC-Q200 test 21 - Board flex: 2 mm flex min.	$ \delta V_n (1 \text{ mA}) < 2 \%$ No visible damage
	Vibration	CECC 42200, Test 4.15, Test Fc, IEC 68-2-6, AEC-Q200 Test 14 Frequency range 10 to 55 Hz (AEC: 10-2000 Hz) Amplitude 0.75 m/s ² or 98 m/s ² (AEC: 5 g for 20 minutes) To- tal duration 6 h (3x2 h) (AEC: 12 cycles each of 3 directions) Waveshape - half sine	lδV _n (1 mA)l < 2 % No visible damage
	Mechanical Shock	CECC 42200, Test 4.14, Test Ea, IEC 68-2-27, AEC-Q200 Test 13. Acceleration = 490 m/s ² (AEC: MIL-STD-202-Method 213), Pulse duration = 11 ms, Waveshape - half sine; Number of shocks = $3x6$	lδV _n (1 mA)l < 10 % No visible damage
Electrical Transient Conduction	ISO-7637-1 Pulses	AEC-Q200 Test 30: Test pulses 1 to 3. Also other pulses - freestyle.	lδV _n (1 mA)l < 10 % No visible damage

Terminology

Term S	ymbol [Definition
Rated AC VoltageV		Maximum continuous sinusoidal AC voltage (<5 % total harmonic distortion) which may be applied to the component under continuous operation conditions at +25 $^{\circ}$ C
	L	Maximum continuous DC voltage (<5 % ripple) which may be applied to the component under continuous operating conditions at +25 °C
Supply VoltageV		The voltage by which the system is designated and to which certain operating characteristics of the system are referred; $V_{rms} = 1.1 \text{ x V}$
Leakage CurrentI _d		The current passing through the varistor at V_{dc} and at +25 $^\circ \! C$ or at any other specified temperature
-		Voltage across the varistor measured at a given reference current (I_{n})
Reference CurrentI _n		
Clamping VoltageV Protection Level		The peak voltage developed across the varistor under standard atmospheric conditions, when passing an 8/20 $\mu \rm s$ class current pulse
Class CurrentI _c		A peak value of current which is 1/10 of the maximum peak current for 100 pulses at two per minute for the 8/20 $\mu \rm s$ pulse
Voltage Clamping RatioV		A figure of merit measure of the varistor clamping effectiveness as defined by the symbols V_c/V_{app} , where ($V_{app} = V_{rms}$ or V_{dc})
Jump Start TransientV		The jump start transient results from the temporary application of an overvoltage in excess of the rated battery voltage. The circuit power supply may be subjected to a temporary overvoltage condition due to the voltage regulation failing or it may be deliberately generated when it becomes necessary to boost start the car.
Rated Single PulseW Transient Energy	C	Energy which may be dissipated for a single 10/1000 μ s pulse of a maximum rated current, with rated AC voltage or rated DC voltage also applied, without causing device failure
Load Dump Transient W	c r	Load Dump is a transient which occurs in automotive environments. It is an exponentially decaying positive voltage which occurs in the event of a battery disconnect while the alter- nator is still generating charging current with other loads remaining on the alternator circui at the time of battery disconnect.
Rated Peak Single PulseIn Transient Current		Maximum peak current which may be applied for a single 8/20 μ s pulse, with rated line voltage also applied, without causing device failure
Rated Transient AverageP Power Dissipation		Maximum average power which may be dissipated due to a group of pulses occurring within a specified isolated time period, without causing device failure at 25 °C
CapacitanceC		Capacitance between two terminals of the varistor measured @ 1 kHz
Non-linearity Exponent α		A measure of varistor nonlinearity between two given operating currents, I_n and I_1 as described by $I = k V exp(a)$, where: - k is a device constant, - $I_1 < I < I_n$ and - a log $(I_1/I_n)/log(V_1/V_n) = 1/log (V_1/V_n)$, where: - I_r is reference current (1 mA) and V_n is varistor voltage - $I_1 = 10 I_n$, V_1 is the voltage measured at I_1
Response Timetr	۲٦	The time lag between application of a surge and varistor's "turn-on" conduction action
Varistor Voltage Temperature To Coefficient	C((V _n @ 85 °C - V _n @ 25 °C) / (V _n @ 25 °C) x 60 °C) x 100
Insulation Resistance IF	RN	Minimum resistance between shorted terminals and varistor surface
Isolation Voltage		The maximum peak voltage which may be applied under continuous operating conditions between the varistor terminations and any conducting mounting surface
Operating Temperature		The range of ambient temperature for which the varistor is designed to operate continuously as defined by the temperature limits of its climatic category
	a [LCT & UCT = Lower and Upper Category Temperature - the minimum and maximum ambient temperatures for which a varistor has been designed to operate continuously. DHD = Dump Heat Test Duration
Storage Temperature		Storage temperature range without voltage applied
Current/Energy Derating	[Derating of maximum values when operated above UCT

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